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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









RGW80TK65

650V 40A Field Stop Trench IGBT

V _{CES}	650V
I _{C (100°C)}	23A
V _{CE(sat) (Typ.)}	1.5V@I _C =40A
P_D	81W

Features

- 1) Low Collector Emitter Saturation Voltage
- 2) High Speed Switching
- 3) Low Switching Loss & Soft Switching
- 4) Pb free Lead Plating; RoHS Compliant

Applications

PFC

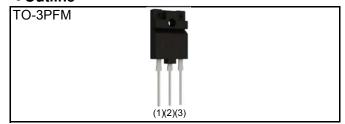
UPS

Welding

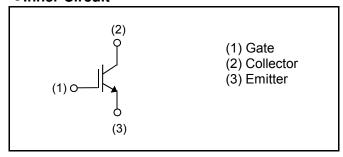
Solar Inverter

ΙH

Outline



●Inner Circuit



Packaging Specifications

	Packaging	Tube			
	Reel Size (mm)				
Typo	Tape Width (mm)	-			
Туре	Basic Ordering Unit (pcs)	450			
	Packing Code	C11			
	Marking	RGW80TK65			

● Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit	
Collector - Emitter Voltage		V_{CES}	650	V	
Gate - Emitter Voltage		V_{GES}	±30	V	
Collector Current	T _C = 25°C	I _C	39	А	
Collector Current	T _C = 100°C	I _C	23	А	
Pulsed Collector Current		I _{CP} *1	160	А	
Power Dissination	T _C = 25°C	P_{D}	81	W	
Power Dissipation	T _C = 100°C	P_{D}	40	W	
Operating Junction Temperature		T _j	-40 to +175	°C	
Storage Temperature		T _{stg}	-55 to +175	°C	

^{*1} Pulse width limited by T_{imax}.

●Thermal Resistance

Parameter	Symbol	Values			Unit
- Faranietei	Зушьы	Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	1.85	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
raiailletei	Symbol Conditions -		Min.	Тур.	Max.	Offic
Collector - Emitter Breakdown Voltage	BV _{CES}	$I_{C} = 10 \mu A, V_{GE} = 0 V$	650	-	-	V
Collector Cut - off Current	I _{CES}	V _{CE} = 650V, V _{GE} = 0V	1	1	10	μΑ
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, V_{CE} = 0V$	-	-	±200	nA
Gate - Emitter Threshold Voltage	$V_{\text{GE(th)}}$	$V_{CE} = 5V, I_{C} = 26.0 \text{mA}$	5.0	6.0	7.0	V
Collector - Emitter Saturation Voltage	V _{CE(sat)}	$I_C = 40A$, $V_{GE} = 15V$ $T_j = 25$ °C $T_j = 175$ °C	-	1.5 1.85	1.9 -	V

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Darameter	Cumbal	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Input Capacitance	C _{ies}	V _{CE} = 30V	-	3320	-	
Output Capacitance	C _{oes}	V _{GE} = 0V	-	83	-	pF
Reverse Transfer Capacitance	C _{res}	f = 1MHz	-	60	-	
Total Gate Charge	Q_g	V _{CE} = 400V	-	110	-	
Gate - Emitter Charge	Q_{ge}	I _C = 40A	-	23	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	41	-	
Turn - on Delay Time	t _{d(on)}	I _C = 40A, V _{CC} = 400V	-	44	-	
Rise Time	t _r	$V_{GE} = 15V, R_{G} = 10\Omega$	-	17	-	
Turn - off Delay Time	t _{d(off)}	T _j = 25°C	-	143	-	ns
Fall Time	t _f	Inductive Load	-	34	-	
Turn - on Switching Loss	E _{on}	*E _{on} includes diode	-	0.76	-	
Turn - off Switching Loss	E _{off}	reverse recovery	-	0.72	-	mJ
Turn - on Delay Time	t _{d(on)}	I _C = 40A, V _{CC} = 400V	-	41	-	
Rise Time	t _r	$V_{GE} = 15V, R_{G} = 10\Omega$	-	18	-	
Turn - off Delay Time	t _{d(off)}	T _j = 175°C	-	158	-	ns
Fall Time	t _f	Inductive Load	-	74	-	
Turn - on Switching Loss	E _{on}	*E _{on} includes diode	-	0.76	-	m l
Turn - off Switching Loss	E _{off}	reverse recovery	-	0.91	-	mJ
		I _C = 160A, V _{CC} = 520V				
Reverse Bias Safe Operating Area	RBSOA	V _P = 650V, V _{GE} = 15V	FU	LL SQUA	RE	-
		$R_G = 100\Omega, T_j = 175^{\circ}C$				

Fig.1 Power Dissipation vs. Case Temperature

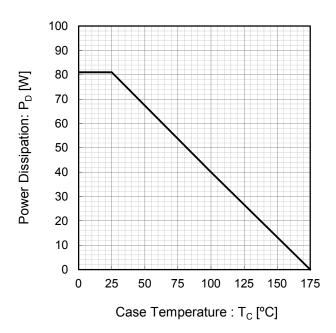


Fig.2 Collector Current vs. Case Temperature

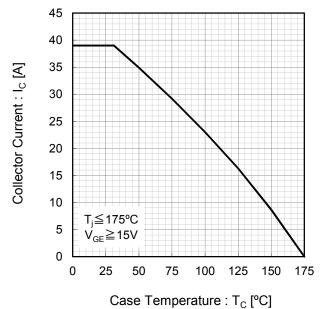


Fig.3 Forward Bias Safe Operating Area

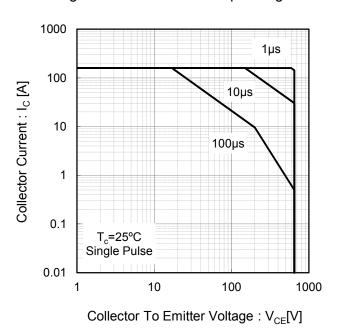


Fig.4 Reverse Bias Safe Operating Area

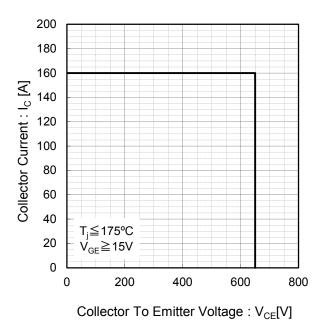


Fig.5 Typical Output Characteristics

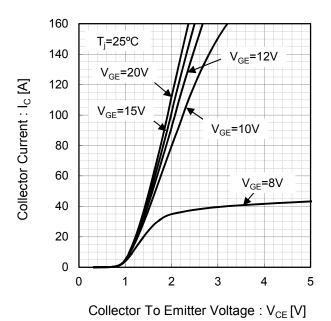
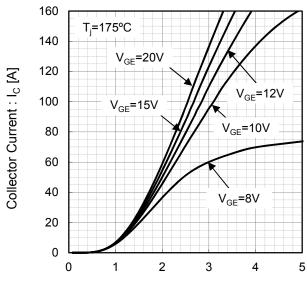


Fig.6 Typical Output Characteristics



Collector To Emitter Voltage : $V_{CE}[V]$

Fig.7 Typical Transfer Characteristics

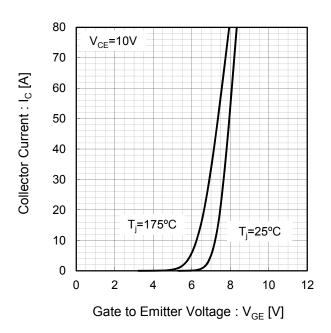


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature

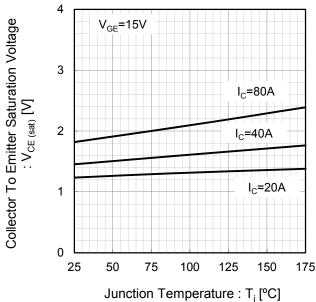
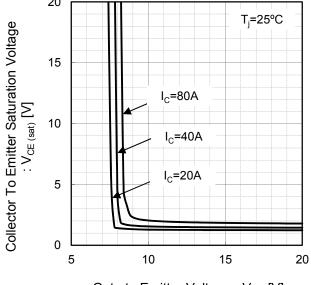
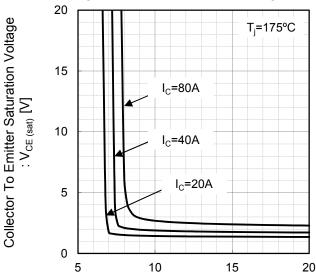


Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate to Emitter Voltage : $V_{GE}[V]$

Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate to Emitter Voltage : V_{GE} [V]

Fig.11 Typical Switching Time vs. Collector Current

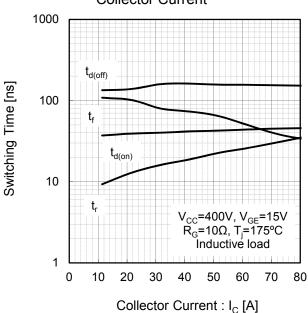


Fig.12 Typical Switching Time vs. Gate Resistance

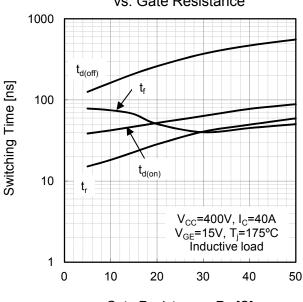


Fig.13 Typical Switching Energy Losses vs. Collector Current 10 Switching Energy Losses [mJ] 1 E_{off} E_{on} 0.1 V_{CC} =400V, V_{GE} =15V R_{G} =10 Ω , T_{j} =175°C Inductive load 0.01 0 10 20 30 40 50 60 70 80 Collector Current : I_C [A]

Fig.14 Typical Switching Energy Losses vs. **Gate Resistance** 10 Switching Energy Losses [mJ] E_{off} 1 E_{on} 0.1 V_{CC}=400V, I_C=40A V_{GE}=15V, T_j=175°C Inductive load 0.01 10 0 20 30 40 50

Gate Resistance : $R_G [\Omega]$

Fig.15 Typical Capacitance vs.
Collector To Emitter Voltage 10000 Cies 1000 Capacitance [pF] Coes 100 Cres 10 f=1MHz V_{GE}=0V =25°C 0.01 0.1 1 10 100 Collector To Emitter Voltage : $V_{CE}[V]$

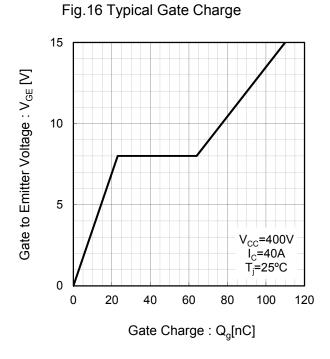
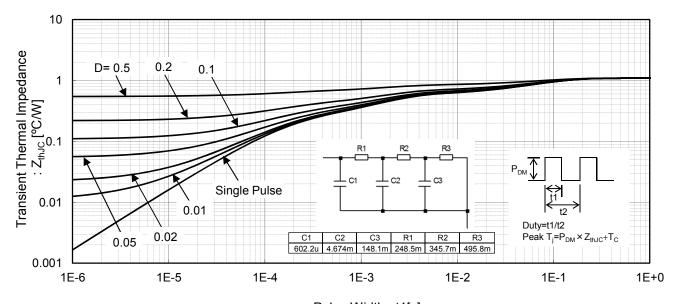


Fig.17 Typical IGBT Transient Thermal Impedance



Pulse Width: t1[s]

•Inductive Load Switching Circuit and Waveform

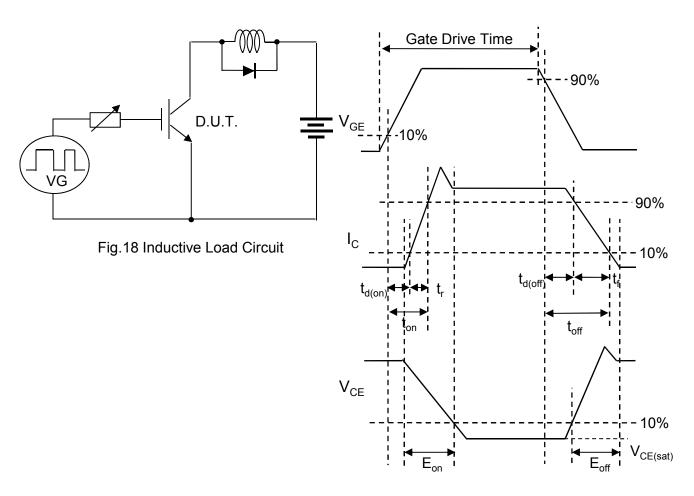


Fig.19 Inductive Load Waveform

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RGW80TK65 - Web Page

Part Number	RGW80TK65
Package	TO-3PFM
Unit Quantity	450
Minimum Package Quantity	30
Packing Type	Tube
Constitution Materials List	inquiry
RoHS	Yes